(650) 793-1051 gurmeet.postbox@gmail.com

Summary

I have over 25 years of leading edge technical experience both as a leader and an individual contributor with a record of highly effective, flawless and prolific execution. I can quickly deploy the highly potent mix of EDA tools, programming and circuits expertise. My strengths include excellent communication and analytical skills, breadth of knowledge and ingenuity.

Experience

[18-20] Machine Learning SOC Startup, Methodology and Global Clocking Engineer

- Defined physical design methodology for 7nm TSMC process corners and timing margins. Place and route on a million gate low voltage design.
- Design of global clock distribution network for a very large 7nm SoC, model the reconvergent network, simulate with spice, implement using ICC2 and resimulate with extracted spice netlist. Publish chip level clock specification document.
- Setup custom compiler schematic and netlisting environment with extracted views. Characterize PVT sensitivity of library cells and level shifters with spice simulations and publish results.
- · Set up and define methodology for an EM/IR flow using Ansys Redhawk/Seascape
- · Support and manage PLL, DLL, DDR, PCIE vendors through weekly meetings.
- · Publish and maintain HOWTO page for new engineers to help them quickly become productive.

[15-17] Consultant

- Physical design methodology and netlist-to-gds flow development in tcl using Cadence toolset. Also Assura physical verification and logical equivalence (lec) flows.
- Hierarchical implementation of an instance array design including floorplanning, power grid, pin placement, place and route, logical equivalence and physical verification. <u>Silicon success.</u>
- · Abstract generation of analog macros and hierarchical instances to allow for through the block routing.
- · Mixed-signal custom CAD support including SKILL programming
- Set up Virtuoso QRC extraction flow for full chip STA, set up and run full chip STA with Tempus, set up and run full chip LEC with Conformal. Silicon success.

[13-14] Oualcomm Technologies, Senior Staff Engineer

 Top level floorplan, power grid with multiple power domains, using CPF/UPF for a mixed signal design, automated floorplan generation with Tcl. Wrote power intent CPF from scratch. Full chip formal (LEC) and low power (CLP) verification using Cadence tools. Apache Redhawk EM/IR analysis, debug and fixes. My leadership enabled a rare ahead of schedule tapeout. Silicon success.

[08-13] Consultant

- · Developed a 40 nm automated and optimized, tapeout ready, Cadence based implementation flow.
- · Wrote Tcl scripts for a correct by construction, tunable flow used for all blocks.
- · Developed automated, tapeout ready, STA setup using Primetime-SI using Tcl/Perl scripts.
- Implemented several large blocks at tapeout quality using the above flow; the resulting GDSII were timing, LEC, LVS/DRC clean. <u>Silicon success</u>.
- · Setup 40nm Cadence based, automated, tapeout ready, block level implementation flow.
- · Hierarchical physical implementation flow in 65nm technology using Cadence.
- Telecom ASIC: Implementation of two large blocks using Magma. <u>Silicon Success.</u>
- · 65nm WiFi ASIC: Implementation of large block using Magma. Silicon Success.
- · 65nm WiFi ASIC: Full chip EM/IR signoff using Apache-Redhawk. Silicon Success.

[06-08] Teranetics, Principal Engineer

• 130nm/65nm 10GBASE-T PHY ASIC: Implement many large blocks, some using <u>x-route</u>. Automate implementation, static timing analysis, logical equivalence and physical verification flows. Power estimation; power reduction using special cells. <u>Silicon Success</u>.

[04-06] Airgo Networks, Physical Design Manager

 Multiple WiFi ASICs: Implement many blocks using Magma. Automate PTSI STA, formal, Calibre PV flows. Full chip EM/IR signoff using Apache-Redhawk. Tapeout signoff/jobview. ECOs, I/O Spice sims, IP integration, Methodology, project management. <u>Silicon success</u>.

[01-04] Transmeta, senior Member, Technical Staff

· 1.2/1.8GHz Efficeon CPUs: Implement Hypertransport PnR blocks; Register File design. ECOs. Setup latch compatible STA flow. Array and noise methodologies. Silicon Success (#1,#2).

[99-01] Sun Microsystems, Member, Technical Staff

- · UltraSparc V CPU: CAM Register File, Custom logic circuit design
- 1.2GHz UltraSparc III CPU: Port a dozen 130nm dynamic circuit blocks, including adders up to 64-bits, from 180nm to 130nm. Silicon success.

[97-99] Intel Corporation, Design Engineer

- 833MHz Pentium III Xeon CPU: High speed dynamic circuit design for L2\$ ECC, L2\$ STA/EM/IR verification. Silicon success.
- · 600 MHz Pentium III CPU : GTL I/O circuit design. Silicon success.

[94-97] ST Microelectronics, Design Engineer

- · Circuit Design of 32kx8, 128kx8 SRAMs. Silicon success. CAD setup.
- · Reverse engineer a register file and re-implement, verify functionality using verilog switch level simulation. Silicon success.

Education

[1989-93] M.Engg., Electrical Comm, Indian Institute of Science

First class with distinction. Alumni medal, Best Student, 1990-93

[1986-89] B.Sc., Physics, Delhi University.

First class with distinction, Gold medal, Best Student: 1987/88/89.